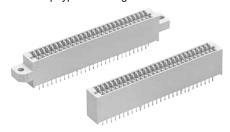
Panasonic ideas for life

Solder-dip type with flange



Solder-dip type without flange

Compliance with RoHS Directive

FOR PC BOARD TO PC BOARD

CARD-EDGE CONNECTORS (AXC)

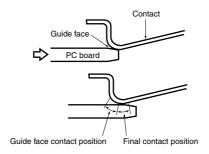
FEATURES

1. Long insertion and removal life.

Thanks to our original contact shape, low insertion force is required and it is designed so that the contact position shifts at the start and end of card insertion. This reduces metal abrasion.

- Standard type: 10,000 times
- Low-insertion-force, long life type: 30.000 times

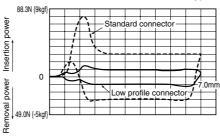
Contact shape



2. Low insertion types are also available.

Among solder-dip types, low insertion types are available with approximately 0.490N, 50gf/ contact and less than 1/4 of the standard connector with a good fit feel.

Insertion/removal force comparison between low insertion and standard types



3. Incorrect or reverse insertion can be prevented.

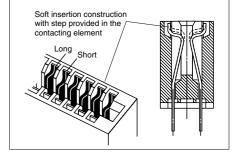
By means of the key to prevent incorrect insertion and the slit fabrication of the printed circuit board, reverse insertion into a printed circuit board block or incorrect insertion into a similarly appearing printed circuit board block can be prevented.

APPLICATIONS

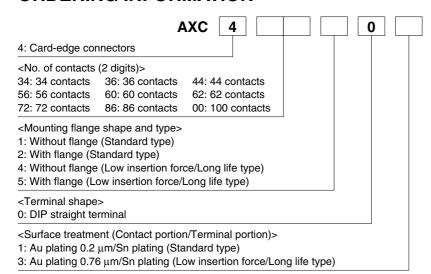
- Communication equipment
- Measuring equipment
- · Factory automation related equipment

What is the low-insertion/long-life type?

This connector employs a unique softinsertion construction with a step provided in the contact. Low insertion power (less than 30% of standard connector) and long life (over 30,000 insertion/removal times) is realized.



ORDERING INFORMATION



PRODUCT TABLE

Time	Standard type	Low insertion force/Long life type		
Туре	Solder-dip straight terminals	Solder-dip straight terminals		
Contact pitches	2.54mm	2.54mm		
Spaces between rows	5.08mm	5.43mm		
	100	100		
	86	86		
	72	72		
No. of contacts	60, 62	60, 62		
No. of contacts	56	56		
	44	44		
	34, 36	34, 36		
	I	_		
Terminal shape	Author Control of the	dayah		
	Solder-dip straight terminal	Solder-dip straight terminal		

Note) Each connector is available with or without flanges.

PRODUCT TYPES

1. Connector

• Standard type (solder-dip straight terminal)

etandara type (ceraer alp etraight terminal)							
No. of	No flange type	No flange type Flange type		Packing quantity			
contacts	Part No.	Part No.	Inner carton	Outer carton			
34	AXC434101	AXC434201					
36	AXC436101	AXC436201					
44	AXC444101	AXC444201		200 pcs.			
56	AXC456101	AXC456201					
60	AXC460101	AXC460201	_				
62	AXC462101	AXC462201					
72	AXC472101	AXC472201					
86	AXC486101	AXC486201					
100	AXC400101	AXC400201					

Note) The row pitch between solder-dip straight terminals of the low-insertionpower/long-life type is different from the card edge connector standard type. • Low insertion force/Long life type (solder-dip straight terminal)

No. of	No flange type	Flange type	Packing	quantity
contacts	Part No.	Part No.	Inner carton	Outer carton
34	AXC434403	AXC434503		
36	AXC436403	AXC436503		
44	AXC444403	AXC444503		
56	AXC456403	AXC456503		
60	AXC460403	AXC460503	_	200 pcs.
62	AXC462403	AXC462503		
72	AXC472403	AXC472503		
86	AXC486403	AXC486503		
100	AXC400403	AXC400503		

Low insertion force/Long life type: Standard type:

5.43mm 5.08mm







2. Keys (Standard type, low insertion force and long life type)

Nama	Part No.	Packing quantity		
Name		Inner carton	Outer carton	
Incorrect insertion prevention key	AXC8001	50 pcs.	200 pcs.	

SPECIFICATIONS

1. Characteristics (Standard type)

Item		Specifications	Conditions
	Rated current	3A	
	Rated voltage	250V AC	
Electrical	Breakdown voltage	1,000 V AC for 1 min.	Detection current: 1mA
characteristics	Insulation resistance	Min. 1,000MΩ	at 500V DC
	Contact resistance	Max. 20mΩ	Measured based on the HP4338B measurement method of JIS C 5402
Mechanical characteristics	Insertion force (unit)	Max. 4.45N {453.6gf}	Measured by steel gauge with 1.78mm thickness and smoothness 0.1s.
	Removal force (unit)	Min. 0.279N {28.4gf}	Measured by steel gauge with 1.37mm thickness and smoothness 0.1s after 3 times insertion of 1.78mm thickness gauge
	Holding force for contact	Min. 9.81N {1kgf}	
Life time characteristics	Insertion and removal life	10,000 times	Replace the PCB board within 2,000 times.
Environmental	Ambient temperature	−55°C to +105°C	No freezing at low temperatures
Environmental characteristics	Soldering temperature resistance	260°C: Within 10 sec.; 300°C: Within 5 sec. 350°C: Within 3 sec.	

2. Characteristics (Low insertion force/Long life type)

	Item	Specifications	Conditions
	Rated current	2A	
	Rated voltage	250V AC	
Electrical	Breakdown voltage	1,000 V AC for 1 min.	Detection current: 1mA
characteristics	Insulation resistance	Min. 1,000MΩ	at 500V DC
	Contact resistance	Max. 20mΩ	Measured based on the HP4338B measurement method of JIS C 5402
Mechanical	Insertion force (Composite)	Max. 39.2N {4.0kgf} (100 contacts) Max. 28.4N {2.9kgf} (72 contacts) Max. 13.7N {1.4kgf} (34 contacts)	The contact face of the 1.6±0.15 mm PC board is gold plated. Guide portion of PC board is chamfered 15°.
characteristics	Removal force (Composite)	Min. 5.88N {0.6kgf} (100 contacts) Min. 4.21N {0.43kgf} (72 contacts) Min. 1.96N {0.2kgf} (34 contacts)	
Life time characteristics	Insertion and removal life	30,000 times	Replace the PCB board within 2,000 times.
	Ambient temperature	−55°C to +105°C	No freezing at low temperatures
Environmental characteristics	Soldering temperature resistance	260°C: Within 10 sec.; 300°C: Within 5 sec. 350°C: Within 3 sec.	

3. Material and surface treatment

	Material		Surface treatment		
Part name	Standard type	Low insertion force/ Long life type	Standard type	Low insertion force/Long life type	
Molded portion	Glass reinforced PBT (UL94V-0)		_		
Contact	Copper alloy		Contact portion: Ni plating on base, Au plating (0.2µm) on surface Terminal portion: Ni plating on base, Sn plating on surface	Contact portion: Ni plating on base, Au plating (0.76μm) on surface Terminal portion: Ni plating on base, Sn plating on surface	

4. Applicable PC board

Standard type, low insertion force and long life type

- Inserting PC board thickness: 1.6±0.15mm
 Mounting PC board thickness: 1.6 to 2.4mm
 Pattern pitch: 2.54±0.05mm
 Pattern width: 1.4mm

- Contact portion: Au plating

DIMENSIONS (Unit: mm)

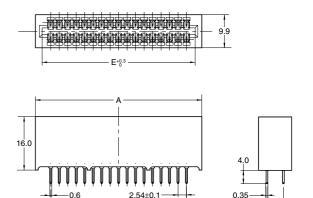
The CAD data of the products with a CAD Data mark can be downloaded from: http://panasonic-electric-works.net/ac

1. Standard type

• Without flange

CAD Data



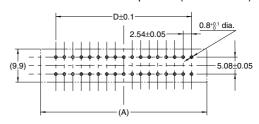


General tolerance: ±0.3

Dimension table (mm)

No. of contacts	А	D	Е
34	49.78	40.64	45.78
36	52.32	43.18	48.32
44	62.48	53.34	58.48
56	77.72	68.58	73.72
60	82.8	73.66	78.8
62	85.34	76.2	81.34
72	98.04	88.9	94.04
86	115.82	106.68	111.82
100	133.6	124.46	129.6

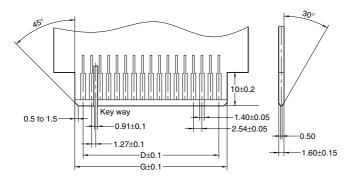
Recommended PC board pattern (Bottom view)



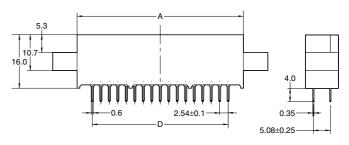
• With flange



Applicable PC board dimensions



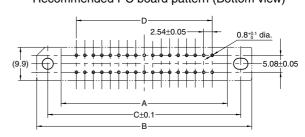
3.3 dia.



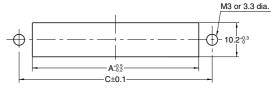
General tolerance: ±0.3

Dimension table (mm)						
No. of contacts	А	В	С	D	Е	G
34	49.78	64.39	57.78	40.64	45.78	45.58
36	52.32	66.93	60.32	43.18	48.32	48.12
44	62.48	77.09	70.48	53.34	58.48	58.28
56	77.72	92.33	85.72	68.58	73.72	73.52
60	82.8	97.41	90.8	73.66	78.8	78.6
62	85.34	99.95	93.34	76.2	81.34	81.14
72	98.04	112.65	106.04	88.9	94.04	93.84
86	115.82	130.43	123.82	106.68	111.82	111.62
100	133.6	148.21	141.6	124.46	129.6	129.4

Recommended PC board pattern (Bottom view)

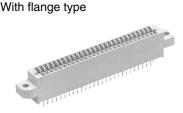


Mounting hole cut-out



2. Low insertion force/Long life type

A) With flange type



B) Without flange type

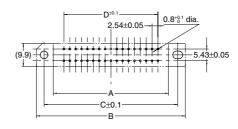
CAD Data



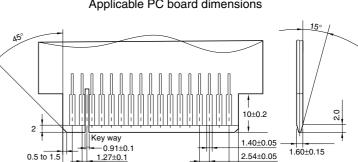
Terminal pitches are different from standard type. Low insertion force/Long life type: 5.43mm Standard type : 5.08mm

General tolerance: ±0.3

Recommended PC board pattern (Bottom view)



Applicable PC board dimensions



D±0.1 G±0.1

Dimension table (mm)

No. of contacts	А	В	С	D	Е	G
34	49.78	64.39	57.78	40.64	45.78	45.58
36	52.32	66.93	60.32	43.18	48.32	48.12
44	62.48	77.09	70.48	53.34	58.48	58.28
56	77.72	92.33	85.72	68.58	73.72	73.52
60	82.8	97.41	90.8	73.66	78.8	78.6
62	85.34	99.95	93.34	76.2	81.34	81.14
72	98.04	112.65	106.04	88.9	94.04	93.84
86	115.82	130.43	123.82	106.68	111.82	111.62
100	133.6	148.21	141.6	124.46	129.6	129.4

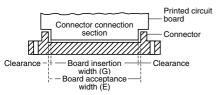
Note) Dimensions of A, D, E and G are common for both types.



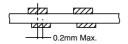
NOTES

1. Cautions regarding printed circuit board fabrication

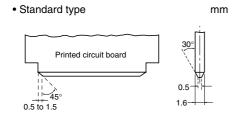
1) Appropriate dimensions for the board insertion width should be provided for the connector connection section of the printed circuit board. If the clearance between the printed circuit board insertion width and that of the connector is large, defective contact or short circuit can be caused. The drawing for the printed circuit board pattern design should provide reference to the clearance as being small.



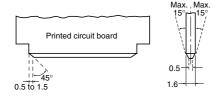
 The pattern shift of the front and back connector connection section of the printed circuit board should be within 0.2mm.



3) Bevelling should be provided without fail for the insertion width of the connector connection section. When the printed circuit board is inserted in the connector, the bevelling will keep distortion of the contacts and insertion force small, improving the insertion capability along with preventing defective contact due to dropping out of the printed circuit board end surface.



Low insertion force/Long life type

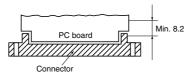


mm

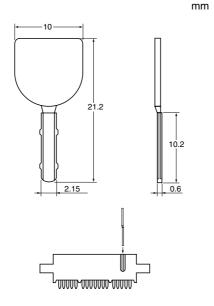
- 4) The proper thickness of printed circuit board should be used.
- 5) Care must be taken with printed circuit board "warp." The extent of the warpage may be exacerbated when the electronic components are mounted on the printed circuit board due to the contraction of the solder on the board. For this reason, ensure that the maximum warp of the area where the connector is mated is 0.1mm.

2. Regarding insertion of printed circuit board

1) Care should be taken to avoid having any oil, flux, or other foreign matter adhere to the insertion section contact surface of the printed circuit board. Foreign matter can lead to defective contact. If such a condition exists, the adhering matter should be removed with alcohol, freon, or other suitable solvent. 2) Insert into connector at least 8.2 mm from the insertion edge of the PC board.



3) By means of a groove fabricated at a designated position, a key (special accessory part) is inserted for the prevention of reverse insertion or incorrect insertion of a similarly appearing printed circuit board.



3. Regarding the operations for dip type soldering

The dip type soldering operations should be carried out under the following conditions.

260°C Within 10 seconds 300°C Within 5 seconds 350°C Within 3 seconds

For other details, please verify with the product specification sheets.